

**Amendments to the Claims:**

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) ~~A Method~~ method for producing an irreversible storage medium ~~comprising including~~ an array of memory cells, each memory cell ~~comprising including~~ one zone of an active layer arranged between first and second conductors, binary information stored in ~~the~~ each memory cell being determined by the electrical conducting state ~~of the~~ of a corresponding zone, ~~the~~ method comprising:

~~assembly of~~ assembling a blank storage medium having ~~an active layer~~ the active layer, which is in an initial insulating ~~state~~, state;

~~production of~~ producing a stamping die having a stamping pattern that corresponds to the binary information to be ~~stored~~, stored; and

~~stamping of~~ the storage medium using the stamping die so as to make predetermined zones of the active layer electrically conductive by means of localised plastic deformation.

2. (Currently Amended) ~~The Method~~ method according to claim 1, wherein the active layer is formed by a charged resin.

3. (Currently Amended) ~~The Method~~ method according to claim 1, wherein ~~assembly of a~~ the assembling the blank storage medium successively ~~comprises~~ includes:

[-] ~~deposition, depositing on a substrate, of~~ substrate, a first conducting layer and ~~of two~~ oppositely doped semi-conducting ~~layers, layers~~;

[-] ~~etching of the~~ a stack formed by the first conducting layer and the two semi-conducting layers so as to obtain a first array of parallel ~~strips, strips~~;

[-] ~~filling the~~ a space between the strips of the first array of parallel strips so as to create a common plane with the strips of the first array of parallel ~~strips, strips~~;

- ~~[-] deposition of~~ depositing the active layer on ~~said the~~ common ~~plane, plane;~~
- ~~[-] deposition of~~ depositing a second conducting layer on the active ~~layer, layer;~~
- ~~etching of~~ the second conducting ~~layer, layer~~ so as to obtain a second array of parallel strips perpendicular to the strips of the first array of ~~strips, strips; and~~
- filling the space between the strips of the second array of parallel strips.

4. (Currently Amended) ~~The Method~~ method according to claim 3, wherein the space between the strips of the first and/or second array of parallel strips is filled by means of a technique using a planarization resin.

5. (Currently Amended) ~~The Method~~ method according to claim 3, wherein the space between the strips of the first and/or second array of parallel strips is filled by means of a mechanical-chemical polishing step.

6. (Currently Amended) ~~The Method~~ method according to claim 1, wherein ~~production of the producing~~ the stamping die successively ~~comprises~~ includes:

- ~~[-] deposition of~~ depositing a photoresist on an intermediate ~~substrate, substrate;~~
- ~~[-] etching, etching~~ in the ~~photoresist, of photoresist,~~ an array of elementary zones having a configuration corresponding to the stamping ~~pattern, pattern;~~
- ~~[-] electrolytic deposition, electrolytically depositing~~ on the intermediate substrate and the ~~photoresist, of photoresist~~ a metal constituting the stamping ~~die, die;~~
- ~~[-] detachment of~~ detaching the stamping die from the intermediate ~~substrate, substrate;~~
- and
- ~~[-] removal of~~ removing the residues of ~~the~~ photoresist from the stamping die.

7. (Currently Amended) ~~An Irreversible~~ irreversible storage ~~medium,~~ medium ~~obtained by means of a~~ formed by the method according to claim 1.